LUMISSIL

12-RGB/36-LED MATRIX LED DRIVER

August 2024

GENERAL DESCRIPTION

The IS31FL3756 is a general purpose 12×n (n=1~3) LED Matrix programmed via 1MHz I2C compatible interface. Each LED can be dimmed individually with 12-bit PWM data and each current sink has 8-bit DC scaling (Color Calibration) data which allowing 4096 steps of linear PWM dimming and 256 steps of DC current adjustable level.

Additionally each LED open and short state can be detected, IS31FL3756 store the open or short information in Open Short Registers. The Open Short Registers allowing MCU to read out via I2C compatible interface. Inform MCU whether there are LEDs open or short and the locations of open or short LEDs.

The IS31FL3756 operates from 2.7V to 5.5V and features a very low shutdown and operational current.

IS31FL3756 is available in QFN-20 (3mm×3mm) package. It operates from 2.7V to 5.5V over the temperature range of -40°C to +125°C.

FEATURES

- Supply voltage range: 2.7V to 5.5V
- 12 current sinks
- Support 12×n (n=1~3) LED matrix configurations
- Ultra-low operational current (0.5mA Typ. 0.65mA Max. at V_{CC}=3.6V, 12bit PWM mode, 500Hz)
- Accurate color rendition
 - 8/12-bit PWM for each dot
 - 8-bit correction/CS
 - 8-bit global current adjust
- SDB rising edge reset I2C module
- 64kHz PWM frequency (8-bit PWM mode)
- 1MHz I2C-compatible interface
- Individual open and short error detect function
- 180 degree phase delay operation to reduce power noise
- Spread spectrum
- De-ghost
- QFN-20 (3mm×3mm) package
- RoHS & Halogen-Free Compliance
- TSCA Compliance

APPLICATIONS

- Hand-held devices for LED display
- Gaming device (Mouse, Mouse MAT etc.)
- IOT device (Al speaker etc.)

TYPICAL APPLICATION CIRCUIT

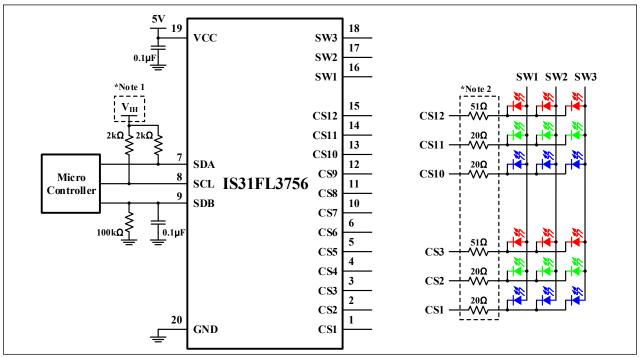


Figure 1 Typical Application Circuit: 12×3, 12 RGBs



TYPICAL APPLICATION CIRCUIT (CONTINUED)

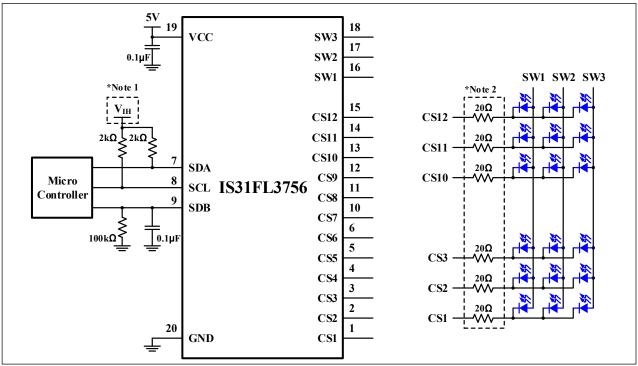


Figure 2 Typical Application Circuit: 36 Mono Color LEDs

Note 1: V_{IH} is the high level voltage for IS31FL3756, which is usually same as V_{CC} of Micro Controller, e.g. if V_{CC} of Micro Controller is 3.3V, V_{IH} = 3.3V. If V_{CC} = 5V and V_{IH} is lower than 2.8V, recommend to add level shift circuit.

Note 2: These optional resistors are for offloading the thermal dissipation (P=l²R) away from the IS31FL3756 only, recommend maximum resistor value $R_{LED}=(V_{LED+}-V_F-V_{HRSW}-V_{HRCS})/I_{OUT(PEAK)},V_{LED+}$ is the power of LED, V_F is the forward voltage of LED, V_{HRSW} is the headroom of SW pins, V_{HRCS} is the headroom of CS pins.



PIN CONFIGURATION

Package	Pin Configuration (Top View)
QFN-20	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

PIN DESCRIPTION

No.	Pin	Description			
1~6, 10~15	CS1~CS12	Current sink pin for LED matrix.			
7	SDA	I2C compatible serial data.			
8	SCL	I2C compatible serial clock.			
9	SDB	Shutdown pin.			
16~18	SW1~SW3	Power SW.			
19	VCC	Power for current source SW and analog.			
20	GND	Ground.			
	Thermal Pad	Connect to GND.			



ORDERING INFORMATION

Industrial Range: -40°C to +125°C

Order Part No.	Package	QTY/Reel
IS31FL3756-QFLS4-TR	QFN-20, Lead-free	2500

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- a.) the risk of injury or damage has been minimized;
- b.) the user assume all such risks; and
- c.) potential liability of Lumissil Microsystems is adequately protected under the circumstances



ABSOLUTE MAXIMUM RATINGS

Supply voltage, Vcc	-0.3V ~+6.0V
Voltage at any input pin	-0.3V ~ V _{CC} +0.3V
Maximum junction temperature, T _{JMAX}	+150°C
Storage temperature range, T _{STG}	-65°C ~+150°C
Operating temperature range, T _A =T _J	-40°C ~ +125°C
Package thermal resistance, junction to ambient (4-layer standard test PCB based on JESD 51-2A), θ_{JA}	57.5°C/W
ESD (HBM)	±6kV
ESD (CDM)	±750V

Note 3: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

The following specifications apply for V_{CC}= 5V, T_A= 25°C, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V_{CC}	Supply voltage		2.7		5.5	V
		V _{CC} = 5V, V _{SDB} = V _{CC} , all LEDs off, 8bit mode, PFS= "000" (64kHz), PSM= "1", SWPD= "000", CSPU= "000"		0.95	1.1	
laa	Quiescent power supply	V_{CC} = 5V, V_{SDB} = V_{CC} , all LEDs off, 12bit mode, PFS= "111" (500Hz), PSM= "1", SWPD= "000", CSPU= "000"		0.57	0.75	m 1
Icc	current	V _{CC} = 3.6V, V _{SDB} = V _{CC} , all LEDs off, 8bit mode, PFS= "000" (64kHz), PSM= "1", SWPD= "000", CSPU= "000"		0.72	0.9	mA
		V _{CC} = 3.6V, V _{SDB} = V _{CC} , all LEDs off, 12bit mode, PFS= "111" (500Hz), PSM= "1", SWPD= "000", CSPU= "000"		0.5	0.65	
		V _{SDB} = 0V		0.5	1	
I _{SD} Shu	Shutdown current	V _{SDB} = V _{CC} , Configuration Register written "0000 0000"		0.5	1	μA
l _{out}	Output current of CSy	GCC= 0xFF, SL= 0xFF		48		mA
ΔI_{MAT}	Between channels	LCAI= "0", I _{OUT} = 42mA, GCC= 0xE0, SL= 0xFF	-6		6	%
ΔI_{ACC}	Between device to device	LCAI= "0", I _{OUT} = 42mA, GCC= 0xE0, SL= 0xFF	-6		6	%
ΔI_{MAT}	Between channels	LCAI= "1", I _{OUT} = 3mA, GCC= 0x80, SL= 0xFF	-6		6	%
ΔΙΑCC	Between device to device	LCAI= "1", I _{OUT} = 3mA, GCC= 0x80, SL= 0xFF	-6		6	%
V	Current switch headroom voltage SWx	I _{SW} = 504mA, GCC= 0xE0, SL= 0xFF		375	500	m\/
V_{HR}	Current sink headroom voltage CSy	I _{CS} = 42mA, GCC= 0xE0, SL= 0xFF		250	350	mV
4	Derived of econoling of CVV	12bit mode, PFS= "100" (4kHz)	200	235	260	μs
t SCAN	Period of scanning of SWx	8bit mode, PFS= "000" (64kHz)		15.4		μs



ELECTRICAL CHARACTERISTICS (CONTINUE)

The following specifications apply for V_{CC}= 5V, T_A= 25°C, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
t _{NOL1}	Non-overlap blanking time during scan, the SWx and SWx+1 are all off during this time	12bit mode, PFS= "100" (4kHz) or 8bit mode, PFS= "000" (64kHz)	0.18	0.29	0.40	μs
t _{NOL2}	Delay total time for CS1 to CS 12	12bit mode, PFS= "100" (4kHz) or 8bit mode, PFS= "000" (64kHz) (Note 4)		0.12		μs
V _{OD}	LED open detect threshold	V _{CC} = 5V, I _{OUT} ≥ 1mA, PWM> 6%, measured at CSy	0.08	0.1	0.26	٧
V _{SD}	LED short detect threshold	V _{CC} = 5V, I _{OUT} ≥ 1mA, PWM> 6%, measured at (V _{CC} -V _{SWx})	0.8	1.0	1.2	٧
T _{SD}	Thermal shutdown	(Note 4)		158		°C
T _{SD_HY}	Thermal shutdown hysteresis	(Note 4)		18		°C
Logic Ele	ectrical Characteristics (SDA, S	CL, SDB, AD)				
VIL	Logic "0" input voltage	V _{CC} = 2.7V~5.5V	GND		0.4	V
V _{IH}	Logic "1" input voltage	V _{CC} = 2.7V~5.5V	1.4		Vcc	V
I _{IL}	Logic "0" input current	V _{INPUT} = 0V (Note 4)		5		nA
Iн	Logic "1" input current	V _{INPUT} = V _{CC} (Note 4)		5		nA

DIGITAL INPUT I2C SWITCHING CHARACTERISTICS (NOTE 4)

Oursels al	Damamatan	F	ast Mod	de	Fas	t Mode	Plus	Unito
Symbol	Parameter		Тур.	Max.	Min.	Тур.	Max.	Units
fscL	Serial-clock frequency	-		400	-		1000	kHz
t _{BUF}	Bus free time between a STOP and a START condition			-	0.5		-	μs
thd, sta	Hold time (repeated) START condition	0.6		-	0.26		-	μs
t _{SU, STA}	Repeated START condition setup time	0.6		-	0.26		-	μs
tsu, sto	STOP condition setup time	0.6		-	0.26		-	μs
thd, dat	Data hold time (Note 5)	0		-	0		-	μs
t _{SU, DAT}	Data setup time	100		-	50		-	ns
t _{LOW}	SCL clock low period	1.3		-	0.5		-	μs
t _{HIGH}	SCL clock high period	0.7		-	0.26		-	μs
t _R	Rise time of both SDA and SCL signals, receiving	-		300	-		120	ns
t _F	Fall time of both SDA and SCL signals, receiving	-		300	-		120	ns

Note 4: Guaranteed by design.

Note 5: A device must internally provide a hold time of at least 300ns for the SDA signal (with respect to the V_{IH(min)} (1.4V) of the SCL signal) to bridge the undefined region of the falling edge of SCL.



DETAILED DESCRIPTION

12C INTERFACE

The IS31FL3756 uses a serial bus, which conforms to the I2C protocol, to control the chip's functions with two wires: SCL and SDA. The IS31FL3756 has a 7-bit slave address (A7:A1), followed by the R/W bit, A0. Set A0 to "0" for a write command and set A0 to "1" for a read command. The complete slave address is:

Table 1 Slave Address (Write only):

Bit	A7:A1	A0
Value	1000100	0

The SCL line is uni-directional. The SDA line is bi-directional (open-drain) with a pull-up resistor (typically $2k\Omega$). The maximum clock frequency specified by the I2C standard is 1MHz. In this discussion, the master is the microcontroller and the slave is the IS31FL3756.

The timing diagram for the I2C is shown in Figure 3. The SDA is latched in on the stable high level of the SCL. When there is no interface activity, the SDA line should be held high.

The "START" signal is generated by lowering the SDA signal while the SCL signal is high. The start signal will alert all devices attached to the I2C bus to check the incoming address against their own chip address.

The 8-bit chip address is sent next, most significant bit first. Each address bit must be stable while the SCL level is high.

After the last bit of the chip address is sent, the master checks for the IS31FL3756's acknowledge. The master releases the SDA line high (through a pull-up resistor). Then the master sends an SCL pulse. If the IS31FL3756 has received the address correctly, then it holds the SDA line low during the SCL pulse. If the SDA line is not low, then the master should send a "STOP" signal (discussed later) and abort the transfer.

Following acknowledge of IS31FL3756, the register address byte is sent, most significant bit first. IS31FL3756 must generate another acknowledge indicating that the register address has been received.

Then 8-bit of data byte are sent next, most significant bit first. Each data bit should be valid while the SCL level is stable high. After the data byte is sent, the IS31FL3756 must generate another acknowledge to indicate that the data was received.

The "STOP" signal ends the transfer. To signal "STOP", the SDA signal goes high while the SCL signal is high.

ADDRESS AUTO INCREMENT

To write multiple bytes of data into IS31FL3756, load the address of the data register that the first data byte is intended for. During the IS31FL3756 acknowledge of receiving the data byte, the internal address pointer will increment by one. The next data byte sent to IS31FL3756 will be placed in the new address, and so on. The auto increment of the address will continue as long as data continues to be written to IS31FL3756 (Figure 6).

READING OPERATION

Most of the registers can be read.

To read registers, after I2C start condition, the bus master must send the IS31FL3756 device address with the R/\overline{W} bit set to "0", followed by the register address which determines which register is accessed. then restart I2C, the bus master should send the IS31FL3756 device address with the R/\overline{W} bit set to "1". Data from the register defined by the command byte is then sent from the IS31FL3756 to the master (Figure 7).

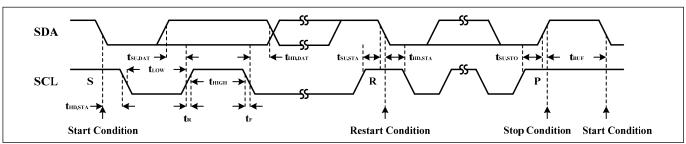


Figure 3 I2C Interface Timing



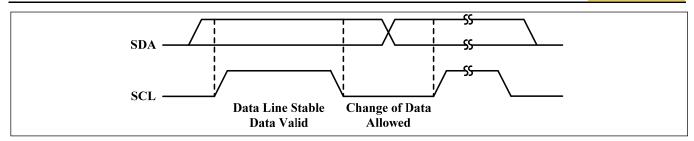


Figure 4 I2C Bit Transfer

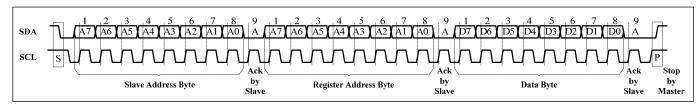


Figure 5 I2C Writing to IS31FL3756 (Typical)

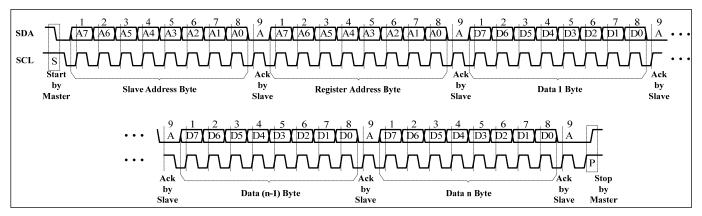


Figure 6 I2C Writing to IS31FL3756 (Automatic Address Increment)

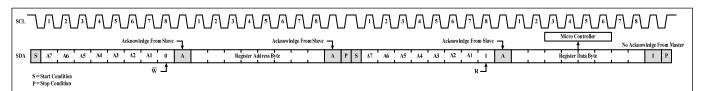


Figure 7 I2C Reading from IS31FL3756



Table 2 Register Definition

Address	Name	Function	Table	R/W	Default
00h	Configuration Register	Configure the operation mode	3	R/W	0000 0010
01h	Global Current Control Register	Set the global current	4	R/W	0000 0000
02h~0Dh	SL of each CS	DC current for each CSy (y=1~12)	5	R/W	0000 0000
0Eh~55h	PWM registers	PWM data of each dot	6	W	0000 0000
60h	Pull Down/Up Voltage Level Selection Register	Set the pull down voltage level for SWx and pull up voltage level for CSy	7	R/W	0011 0100
61h	FPS register	PWM frequency setting	8	R/W	0000 0000
62h~6Dh	Open/short	Open/short information	9	R	0000 0000
6Eh	Spread Spectrum Register	Spread spectrum function enable	10	R/W	0000 0000
7Fh	Reset Register	Reset all register to POR state	-	W	0000 0000

Table 3 00h Configuration Register

Bit	D7	D6	D5:D4	D3	D2	D1	D0
Name	-	PWMM	SWS	DGT_DC	PSM	PHC	SSD
Default	0	0	00	0	0	1	0

The Configuration Register sets operating mode of IS31FL3756.

PWMM	PWM Resolution Mode

0 12-bit mode 8-bit mode 1

SWS	SWx Setting
_	

n=3, SW1~SW3, 1/3 0x

10 n=2, SW1~SW2, 1/2, SW3 no-active 11 All CSy work as current sinks only,

no scan

DGT DC **Deghost Duty Cycle**

3% (8bit mode) or 0.187% (12bit

mode)

6% (8bit mode) or 0.375% (12bit 1

mode)

PSM Shutdown OP when PWM off (to

save ICC)

Do not shutdown OP 0

Shutdown OP 1

PHC Phase Choice

0 0 degree phase delay

CS1, CS3, CS5, CS7... 0 degree 1

phase delay,

CS2, CS4, CS6, CS8...180 degree

phase delay (Default)

SSD Software Shutdown Control

0 Software shutdown Normal operation 1

When SSD is "0", IS31FL3756 works in software shutdown mode and to normal operate the SSD bit should set to "1".

SWS control the duty cycle of the SWx, default mode is 1/3.

Table 4 01h Global Current Control Register

Bit	D7:D0	
Name	GCC	
Default	0000 0000	

The Global Current Control Register modulates all CSy (y=1~12) DC current which is noted as IOUT(PEAK) in 256 steps.

I_{OUT} is computed by the Formula (1):

$$I_{OUT(PEAK)} = 48mA \times \frac{GCC}{256} \times \frac{SL}{256}$$
 (1)

$$GCC = \sum_{n=0}^{7} D[n] \cdot 2^{n} \quad (2)$$

Where D[n] stands for the individual bit value, 1 or 0, in location n. SL is the current scaling register value defined in register 02h~0Dh.

To make sure the IC works at normal current amplify status, the GCC should not less than 0x20.



Table 5 02h~0Dh SL Register

Bit	D7:D0	
Name	SLx	
Default	0000 0000	

The Current Scaling Control Register modulates each CSy (y=1~12) DC current which is noted as lout in 256 steps.

I_{OUT} is computed by the Formula (1):

$$I_{OUT(PEAK)} = 48mA \times \frac{GCC}{256} \times \frac{SL}{256}$$
 (1)

$$GCC = \sum_{n=0}^{7} D[n] \cdot 2^n$$
 (2)

$$SL = \sum_{n=0}^{7} D[n] \cdot 2^n$$
 (3)

Where D[n] stands for the individual bit value, 1 or 0, in location n. GCC is the Global Current Control register value defined in register 01h.

SLx

0000000 0/256 DC current 1/256 DC current 0000001

11111111 255/256 DC current

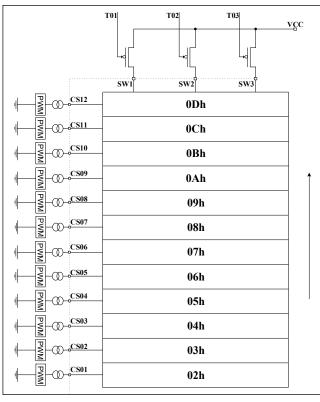


Figure 8 SL Register

Table 6 0Eh~55h PWM Register

Reg	0Fh (11h, 13h)		0Eh (10h, 12h)
Bit	D7:D4 D3:D0		D7:D0
Name	-	PWM_H	PWM_L
Default	0000	0000	0000 0000

High bits of PWM Register PWM H PWM L Low bits of PWM Register

Each dot has 2 bytes to modulate the PWM duty in 4096 steps.

The value of the PWM Registers decides the average current of each LED noted ILED.

ILED computed by Formula (4):

$$I_{LED} = \frac{PWM}{4096} \times I_{OUT(PEAK)} \times Duty \tag{4}$$

$$PWM = \sum_{n=0}^{11} D[n] \cdot 2^{n}$$
 (5)

When PWMM= "1" (D6 of register 00h), each dot has a byte to modulate the PWM duty in 256 steps. ILED computed by Formula (6):

$$I_{LED} = \frac{PWM}{256} \times I_{OUT(PEAK)} \times Duty$$
 (6)

$$PWM = \sum_{n=0}^{7} D[n] \cdot 2^{n}$$
 (7)

When SWS= "0x", in 12-bit PWM mode, PFS= "000" (4kHz PWM frequency), Duty is computed as below:

Duty=
$$\frac{(235-0.12)\mu s}{(235+0.29)\mu s} \times \frac{1}{3} \approx \frac{1}{3}$$
 (8-1)

When SWS= "0x" and in 8-bit PWM mode, PFS= "000" (64kHz PWM frequency), Duty is computed as below:

$$Duty = \frac{(15.4 - 0.12)\mu s}{(15.4 + 0.29)\mu s} \times \frac{1}{3} \approx \frac{1}{3.08}$$
 (8-2)

When SWS= "10", in 12-bit PWM mode, PFS= "'000" (4kHz PWM frequency), Duty is computed as below:

Duty=
$$\frac{(235-0.12)\mu s}{(235+0.29)\mu s} \times \frac{1}{2} \approx \frac{1}{2}$$
 (8-3)

When SWS= "10" and in 8-bit PWM mode, PFS= "000" (64kHz PWM frequency), Duty is computed as below:

$$Duty = \frac{(15.4 - 0.12)\mu s}{(15.4 + 0.29)\mu s} \times \frac{1}{2} \approx \frac{1}{2.05}$$
 (8-4)

Where 235µs and 15.4µs is t_{SCAN}, the period of scanning of SWx, 0.29µs is t_{NOL1}, 0.12µs is t_{NOL2}, the non-overlap time and CSy (y=1~12) delay time



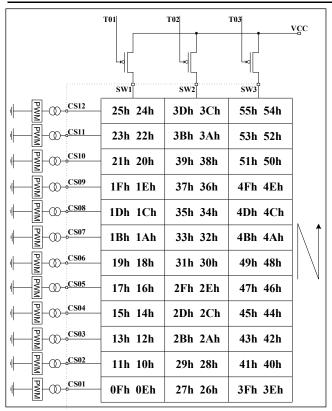


Figure 9 PWM Register

Table 7 60h Deghost Selection Register

Bit	D7	D6:D4	D3	D2:D0
Name	SWATEN	SWPD	CSATEN	CSPU
Default	0	011	0	100

SWPD set pull down voltage for SWx ($x=1\sim3$) and CSPU pull up voltage for CSy ($y=1\sim12$).

SWATEN 0 1	SW pull down only in non-overlap time or all the time In non-overlap time only All the time	
CSATEN	CS pull up only in non-overlap time or all the time	
0	In non-overlap time only	
1	All the time	
SWPD	SWx Pull Down Selection Bit	
SWPD 000	SWx Pull Down Selection Bit No pull down	
000	No pull down	
000 001	No pull down 1.6V	
000 001 010	No pull down 1.6V 1.47V	
000 001 010 011	No pull down 1.6V 1.47V 1.32V	
000 001 010 011 100	No pull down 1.6V 1.47V 1.32V 1.18V	

CSPU	CSy Pull up Selection Bit
000	No pull up
001	Vcc-1.47V
010	Vcc-1.33V
011	V _{CC} -1.2V
100	V _{CC} -1.07V
101	V _{CC} -0.93V
110	V _{CC} -0.8V
111	Vcc

Table 8 61h Open Short Enable Register

Bit	D7	D6:D4	D3:D2	D1	D0
Name	LCAI	PFS	MDT	SEN	OEN
Default	0	000	00	0	0

LCAI bit is a current multiplier of all output's current. When LCAI = "0", I_{OUT(PEAK)} follow the formula below or refer formula (1).

$$I_{OUT(PEAK)} = 48mA \times \frac{GCC}{256} \times \frac{SL}{256}$$
 (1)

When LCAI = "1", the output current will become 1/4 of above setting, which is:

$$I_{OUT(PEAK)} = 12mA \times \frac{GCC}{256} \times \frac{SL}{256}$$
 (9)

For applications of I_{OUT(PEAK)}=8mA~48mA, LCAI should be set to "0".

For applications of $I_{OUT(PEAK)}=0~8mA$, recommend to set LCAI to "1" to ensure good Δ_{IMAT} and Δ_{IOUT} .

OEN 0 1	Open detect enable Open detect disable Open detect enable		
SEN 0 1	Short detect enable Short detect disable Short detect enable		
MDT	Minimum PWM on duty cycle when detect		
00	6%		
01	3%		
1x	12%(only can be active at PWM mode = 8bit)		
PFS	PWM frequency setting		
000	64kHz for 8-bit mode,		
	4kHz for 12-bit mode		
001	32kHz for 8-bit mode,		
	4kHz for 12-bit mode		
010	16kHz for 8-bit mode, 4kHz for 12-bit mode		



011	8kHz for 8-bit mode, 4kHz for 12-bit mode
100	4kHz for 8-bit mode/12-bit mode
101	2kHz for 8-bit mode/12-bit mode
110	1kHz for 8-bit mode/12-bit mode
111	500Hz for 8-bit mode/12-bit mode
LCAI 0 1	Low current accuracy improve bit No effect Improve the accuracy of low current

Table 9 62h~6Dh Open/Short Register (Read Only)

Bit	D7:D6	D5:D0
Name	-	CS12:CS7, CS6:CS1
Default	00	00 0000

When OEN (61h) is set to "1", open detection will be trigger once, and the open information will be stored at 62h~67h.

When SEN (61h) set to "1", short detection will be trigger once, and the short information will be stored at 68h~6Dh.

In order to have accurate open and short result, before set OEN/SEN bit, the GCC should set to 0x0F, the 60h should set to 0x00 (disable the deghost function) and the PWM value should >6%.

Duty is about 1/3.1 when SWS= "0x".

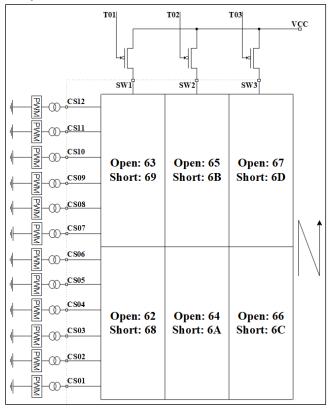


Figure 10 PWM Register

Table 10 6Eh Spread Spectrum Register

Bit	D7:D5	D4	D3:D0
Name	-	SSP	-
Default	000	0	0000

When SSP enable, it will adjust the range ($\pm 5.6\%$) and cycle time (2099µs) of spread spectrum function.

SSP Spread Spectrum Function Enable

0 Disable1 Enable

7Fh Reset Register

Once user writes the Reset Register with 0xAE, IS31FL3756 will reset all the IS31FL3756 registers to their default value. On initial power-up, the IS31FL3756 registers are reset to their default values for a blank display.

LUMISSIL MICROSYSTEMS

APPLICATION INFORMATION

SCANING TIMING

As shown in Figure 11, the SW1~SW3 is turned on by serial, LED is driven 3 by 3 within the SWx (x=1~3) on time (SWx, x=1~3 is source and it is high when LED on), including the non-overlap blanking time during scan, the duty cycle of SWx (active high, x=1~3) is:

When SWS= "0x", in 12-bit PWM mode, PFS= "000" (4kHz PWM frequency), Duty is computed as below:

Duty=
$$\frac{(235-0.12)\mu s}{(235+0.29)\mu s} \times \frac{1}{3} \approx \frac{1}{3}$$
 (8-1)

When SWS= "0x", in 8-bit PWM mode, PFS= "000" (64kHz PWM frequency), Duty is computed as below:

Duty=
$$\frac{(15.4-0.12)\mu s}{(15.4+0.29)\mu s} \times \frac{1}{3} \approx \frac{1}{3.08}$$
 (8-2)

When SWS= "10", in 12-bit PWM mode, PFS= "000" (4kHz PWM frequency), Duty is computed as below:

Duty =
$$\frac{(235-0.12)\mu s}{(235+0.29)\mu s} \times \frac{1}{2} \approx \frac{1}{2}$$
 (8-3)

When SWS= "10", in 8-bit PWM mode, PFS= "000" (64kHz PWM frequency), Duty is computed as below:

$$Duty = \frac{(15.4 - 0.12)\mu s}{(15.4 + 0.29)\mu s} \times \frac{1}{2} \approx \frac{1}{2.05}$$
 (8-4)

Where 235 μ s and 15.4 μ s is t_{SCAN}, the period of scanning of SWx, 0.29 μ s is t_{NOL1}, 0.12 μ s is t_{NOL2}, the non-overlap time and CSy (y=1~12) delay time.

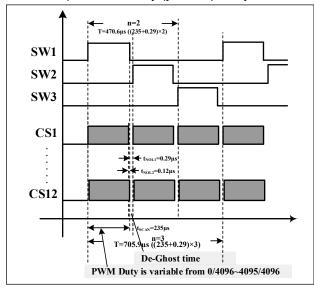


Figure 11 Scanning Timing

CURRENT SETTING

The maximum output current I_{OUT(PEAK)} of CS1~CS12 can be adjusted by the GCC register in 256 steps, and each CSx's I_{OUT(PEAK)} can be adjusted by SL register in 256 steps as described in Formula (1).

IOUT(PEAK) is computed by the Formula (1):

$$I_{OUT(PEAK)} = 48mA \times \frac{GCC}{256} \times \frac{SL}{256}$$
 (1)

$$GCC = \sum_{n=0}^{7} D[n] \cdot 2^n$$
 (2)

$$SL = \sum_{n=0}^{7} D[n] \cdot 2^n \qquad (3)$$

Where D[n] stands for the individual bit value, 1 or 0, in location n. GCC is the Global Current Control register value defined in register 01h, SL is the current scaling register value defined in register 02h~0Dh.

The LCAI bit in 61h is a current multiplier of all output's current.

When LCAI= "0", I_{OUT(PEAK)} follow the formula below or refer formula (1).

When LCAI= "1", the output current will become 1/4 of above setting, which is:

$$I_{OUT(PEAK)} = 12mA \times \frac{GCC}{256} \times \frac{SL}{256}$$
 (9)

For applications of $I_{OUT(PEAK)}$ =8mA~48mA, LCAI should be set to "0", for applications of $I_{OUT(PEAK)}$ =0~8mA, recommend to set LCAI to "1" to ensure good Δ_{IMAT} and Δ_{IOUT} .

Some applications may require the IOUT of each channel need to be adjusted independently. For example, if CS1 drives 1 LED and CS2 drives 2 parallel LEDs, and they should have the same average current like 18mA, we can set the I_{OUT(Max)} to 36mA, and GCC=0xFF, 4Ch=0x80, 4Dh=0xFF, the CS1 sinks about 18mA and CS2 sinks 36mA which can have two LEDs in parallel.

Another example, CS1, CS2 and CS3 drive an RGB LED, CS1 is Red LED, CS2 is Green LED and CS 3 is Blue LED, with same GCC and same SL bits, when CS1 CS2 and CS3 have the same PWM value, the LED may look a litter pink, or not so white, in this case, the SL bits can be used to adjust the single ICSx of some output and make it pure white color. We call this SL bits another name: white balance registers.



PWM CONTROL

The PWM Registers (0Eh~55h) can modulate LED brightness of each channel with 256/4096 steps. For example, if the data in PWM_H register is "0000 0000" and in PWM_L register is "0000 0100", then the PWM is the fourth step.

The average LED current I_{LED} of each LED is also decided by PWM value of each LED. Each LED has 2 bytes to modulate the PWM duty in 4096 steps.

I_{LED} computed by Formula (4):

$$I_{LED} = \frac{PWM}{4096} \times I_{OUT(PEAK)} \times Duty$$
 (4)

$$PWM = \sum_{n=0}^{11} D[n] \cdot 2^{n}$$
 (5)

When PWMM= "1" (D6 of register 00h), each dot has a byte to modulate the PWM duty in 256 steps. I_{LED} computed by Formula (6):

$$I_{LED} = \frac{PWM}{256} \times I_{OUT(PEAK)} \times Duty$$
 (6)

$$PWM = \sum_{n=0}^{7} D[n] \cdot 2^{n}$$
 (7)

When SWS= "0x" and in 12-bit PWM mode, Duty is computed as below:

Duty=
$$\frac{(235-0.12)\mu s}{(235+0.29)\mu s} \times \frac{1}{3} \approx \frac{1}{3}$$
 (8-1)

When SWS= "0x" and in 8-bit PWM mode, Duty is computed as below:

Duty=
$$\frac{(15.4-0.12)\mu s}{(15.4+0.29)\mu s} \times \frac{1}{3} \approx \frac{1}{3.08}$$
 (8-2)

When SWS= "10" and in in 12-bit PWM mode, Duty is computed as below:

Duty =
$$\frac{(235-0.12)\mu s}{(235+0.29)\mu s} \times \frac{1}{2} \approx \frac{1}{2}$$
 (8-3)

When SWS= "10" and in in 8-bit PWM mode, Duty is computed as below:

Duty =
$$\frac{(15.4 - 0.12)\mu s}{(15.4 + 0.29)\mu s} \times \frac{1}{2} \approx \frac{1}{2.05}$$
 (8-4)

Where 235 μ s and 15.4 μ s is t_{SCAN} , the period of scanning of SWx, 0.29 μ s is t_{NOL1} , 0.12 μ s is t_{NOL2} , the non-overlap time and CSy (y=1~12) delay time.

Writing new data continuously to the registers can modulate the brightness of the LEDs to achieve a breathing effect.

PWM FREQUENCY SELECT

The IS31FL3756 output channels operate with a default 12 bit PWM resolution and the PWM frequency of 4kHz. Because all the CSx channels are almost synchronized, the DC power supply will experience large instantaneous current surges when the CSx channels turn ON. These current surges will generate an AC ripple on the power supply which cause stress to the decoupling capacitors. When the AC ripple is applied to a monolithic ceramic capacitor chip (MLCC) it will expand and contract causing the PCB to flex and generate audible hum in the range of between 300Hz to 18kHz, To avoid this hum, there are many countermeasures, such as selecting the capacitor type and value which will not cause the PCB to flex and contract.

An additional option for avoiding audible hum is to set the IS31FL3756's output PWM frequency above/below the audible range. The PFS bits (61h) can be used to set the switching frequency to 500Hz~64kHz as shown in Table 8, higher than 20kHz is out of the audible range.

OPEN/SHORT DETECT FUNCTION

IS31FL3756 has open and short detect bit for each LED.

When OEN(61h) is set to "1", open detection will be trigger once, and the open information will be stored at 62h~67h.

When SEN (61h) set to "1", short detection will be trigger once, and the short information will be stored at 68h~6Dh.

In order to have accurate open and short result, before set OEN/SEN bit, the GCC should set to 0x0F and the PWM value should >6%.

SPREAD SPECTRUM FUNCTION

PWM current switching of LED outputs can be particularly troublesome when the EMI is concerned. To optimize the EMI performance, the IS31FL3756 includes a spread spectrum function. By enable the SSP bit (6Eh) the IS31FL3756 will adjust the range (±5.6%) and cycle time (2099µs) of spread spectrum function. The spread spectrum can spread the total electromagnetic emitting energy into a wider range that significantly degrades the peak energy of EMI. With spread spectrum, the EMI test can be passed with smaller size and lower cost filter circuit.

DE-GHOST FUNCTION

The "ghost" term is used to describe the behavior of an LED that should be OFF but instead glows dimly when another LED is turned ON. A ghosting effect typically can occur when multiplexing LEDs. In matrix architecture any parasitic capacitance found in the constant-current outputs or the PCB traces to



the LEDs may provide sufficient current to dimly light an LED to create a ghosting effect.

To prevent this LED ghost effect, the IS31FL3756 has integrated Pull down voltage setting for each SWx (x=1~3) and Pull up voltage setting for each CSy (y=1~12). Select the right SWx Pull down voltage (60h) and CSy Pull up voltage (60h) which eliminates the ghost LED for a particular matrix layout configuration.

Typically, need to depending on how many LED is connect in series in one LED dot position, selecting the voltage setting will be sufficient to eliminate the LED ghost phenomenon. Recommend setting is

SWPD= 1.32V, CSPU= Vcc-1.07V

Higher value of SWPD and CSPU will have stronger pull ability to led and may let LED have higher reverse voltage.

When IS31FL3756 works in hardware shutdown mode, the de-ghost function should be disabled.

INTERFACE RESET

The I2C will be reset if the SDB pin is pull-high from 0V to logic high, at the operating SDB rising edge, the interface operation is not allowed.

SHUTDOWN MODE

Shutdown mode can be used as a means of reducing power consumption. During shutdown mode all registers retain their data.

Software Shutdown

By setting the SSD bit of the Control Register (00h) to "0", the IS31FL3756 will operate in software shutdown mode. When the IS31FL3756 is in software shutdown, all current sources are switched off, so the LEDs are OFF but all registers accessible. Typical current consume is $0.5\mu A$ (V_{CC} =5V).

Hardware Shutdown

The chip enters hardware shutdown when the SDB pin is pulled low. All analog circuits are disabled during hardware shutdown typical the current consumption is $0.5\mu A$ ($V_{CC}=5V$).

The chip releases hardware shutdown when the SDB pin is pulled high. The rising edge of SDB pin

will reset the I2C module, but the register information retains. During hardware shutdown the registers are accessible.

If the VCC supply drops below 1.75V but remains above 0.1V during SDB pulled low, please reinitialize all Registers before SDB pulled high.

LAYOUT

The IS31FL3756 consumes lots of power so good PCB layout will help improve the reliability of the chip. Please consider below factors when layout the PCB.

Power Supply Lines

When designing the PCB layout pattern, the first step should consider about the supply line and GND connection, especially those traces with high current, also the digital and analog blocks' supply line and GND should be separated to avoid the noise from digital block affect the analog block.

At least one $0.1\mu F$ capacitor, if possible with a more $1\mu F$ capacitor is recommended to connected to the ground at power supply pin of the chip, and it needs to close to the chip and the ground net of the capacitor should be well connected to the GND plane.

Thermal Consideration

The over temperature of the chip may result in deterioration of the properties of the chip. The thermal pad of IS31FL3756 should connect to GND net and need to use 4 or 9 vias connect to GND copper area, the GND area should be as large area as possible to help radiate the heat from the IS31FL3756.

Current Rating Example

For an $I_{OUT(PEAK)}$ =40mA application, the current rating for each net is as follows:

- VCC/VLED+/SWx maximum current is $2mA+40mA\times12=482mA$ when $V_{CC}=5V$, recommend trace width for them is: $0.30mm\sim0.5mm$
- Output pins=40mA, recommend trace width is 0.2mm~0.254mm
- All other pins<3mA, recommend trace width is 0.15mm~0.254mm



CLASSIFICATION REFLOW PROFILES

Profile Feature	Pb-Free Assembly
Preheat & Soak Temperature min (Tsmin) Temperature max (Tsmax) Time (Tsmin to Tsmax) (ts)	150°C 200°C 60-120 seconds
Average ramp-up rate (Tsmax to Tp)	3°C/second max.
Liquidous temperature (TL) Time at liquidous (tL)	217°C 60-150 seconds
Peak package body temperature (Tp)*	Max 260°C
Time (tp)** within 5°C of the specified classification temperature (Tc)	Max 30 seconds
Average ramp-down rate (Tp to Tsmax)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

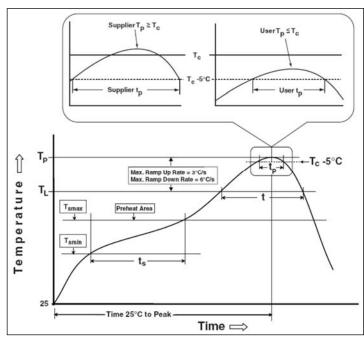
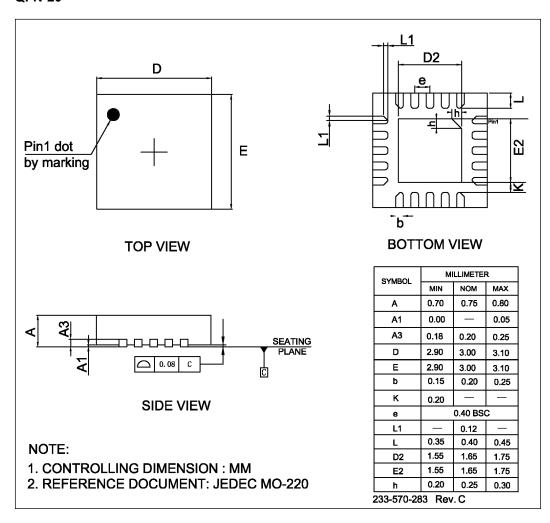


Figure 12 Classification Profile



PACKAGE INFORMATION

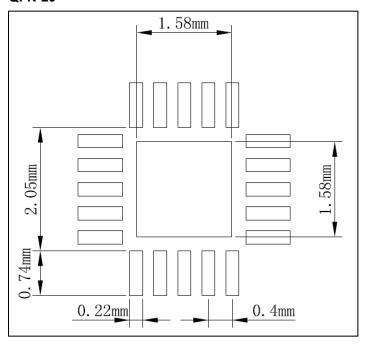
QFN-20





RECOMMENDED LAND PATTERN

QFN-20



Note:

- 1. Land pattern complies to IPC-7351.
- 2. All dimensions in MM.
- 3. This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depends on many factors unknown (eg. User's board manufacturing specs), user must determine suitability for use.



REVISION HISTORY

Revision	Detail Information	Date
0A	Initial release	2021.06.02
Α	Update EC table	2021.07.15
В	Update tscan Update description for calculators 8	2021.09.15
С	Update to new Lumissil logo Add RoHS	2024.08.22